

# UNISONIC TECHNOLOGIES CO., LTD

UT3400 Power MOSFET

# 5.8A, 30V N-CHANNEL ENHANCEMENT MODE POWER MOSFET

#### DESCRIPTION

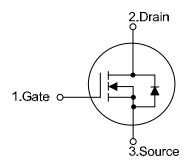
The UTC **UT3400** is an N-ch enhancement MOSFET providing the customers with perfect  $R_{DS(ON)}$  and low gate charge. This device can be operated with 2.5V low gate voltage.

The UTC **UT3400** is optimized for applications, such as a load switch or in PWM.

#### ■ FEATURES

\*  $R_{DS(ON)} \le 28m\Omega$  @  $V_{GS}=10V$ ,  $I_D=5.8A$   $R_{DS(ON)} \le 33m\Omega$  @  $V_{GS}=4.5V$ ,  $I_D=5.0A$   $R_{DS(ON)} \le 52m\Omega$  @  $V_{GS}=2.5V$ ,  $I_D=4.0A$ 

#### ■ SYMBOL

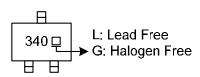


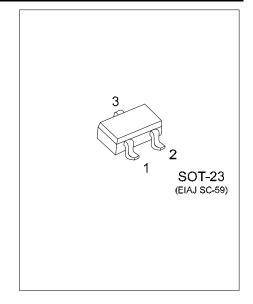
### ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
UT3400L-AE3-R UT3400G-AE3-R		SOT-23	G	S	D	Tape Reel	
Note: Pin Assignment: G: Ga	ate S: Source D: Drain		•			•	

UT3400G-AE3-R
(1)Packing Type
(1) R: Tape Reel
(2) AE3: SOT-23
(3)Green Package
(3) G: Halogen Free and Lead Free, L: Lead Free

#### MARKING





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## ■ ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub>=25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	±12	V
Continuous Drain Current	$I_{D}$	5.8	Α
Pulsed Drain Current (Note 2)	I <sub>DM</sub>	30	Α
Power Dissipation	$P_{D}$	1.4	W
Junction Temperature	$T_J$	+150	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. Pulse width ≤300µs, duty cycle≤0.5%.

#### ■ THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Junction to Ambient (Note)	$\theta_{JA}$		85	125	°C/W

Note: Surface mounted on 1 in<sup>2</sup> copper pad of FR4 board with 2oz

# ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

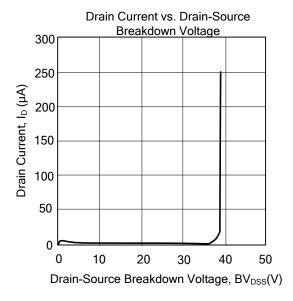
DADAMETED	OVALDOL	TEGT COMPLETIONS	N ALN I	TVD	NAAN	LINIT
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	WAX	UNIT
OFF CHARACTERISTICS	5)./	V 0V 1 050 A	-00	1	1	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	$V_{GS} = 0V, I_D = 250 \mu A$	30		_	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =24V,V <sub>GS</sub> =0V			1	μΑ
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS} = \pm 12V, V_{DS} = 0V$			100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS(TH)}$ $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$		1.1	1.4	V
On-State Drain Current	$I_{D(ON)}$	V <sub>DS</sub> =5V, V <sub>GS</sub> =4.5V				Α
		$V_{GS} = 10V, I_D = 5.8A$		22.8	28	mΩ
Drain to Source On-state Resistance	$R_{DS(ON)}$	$V_{GS}$ =4.5V, $I_D$ =5A		27.3	33	mΩ
		$V_{GS} = 2.5V, I_D = 4 A$		43.3	52	mΩ
DYNAMIC PARAMETERS			-			
Input Capacitance	C <sub>ISS</sub>			823		pF
Output Capacitance	Coss	V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f =1MHz		99		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			77		pF
Gate Resistance	$R_G$	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f =1MHz		1.2		Ω
SWITCHING PARAMETERS						
Total Gate Charge	$Q_{G}$			9.7		nC
Gate Source Charge	$Q_GS$	$V_{GS} = 4.5V, V_{DS} = 15V, I_{D} = 5.8A$		1.6		nC
Gate Drain Charge	$Q_GD$			3.1		nC
Turn-ON Delay Time	t <sub>D(ON)</sub>			5.5		ns
Turn-ON Rise Time	t <sub>R</sub>	V <sub>GS</sub> =10V,V <sub>DS</sub> =15V		5.1		ns
Turn-OFF Delay Time	t <sub>D(OFF)</sub>	$R_L = 2.7\Omega, R_{GEN} = 6\Omega$		37		ns
Turn-OFF Fall-Time	t <sub>F</sub>			4.2		ns
SOURCE- DRAIN DIODE RATINGS AND CHA	ARACTERIS	STICS				
Diode Continuous Forward Current ( Note 1)	Is				2.5	Α
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =1A, V <sub>GS</sub> =0V		0.71	1	V
Reverse Recovery Time	t <sub>rr</sub>			16		ns
Reverse Recovery Charge	Qrr	I <sub>F</sub> =5A, dl/dt=100A/μs		8.9		nC

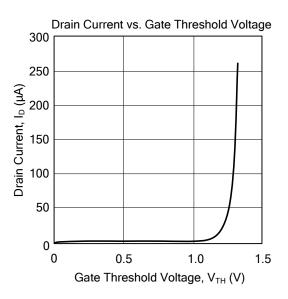
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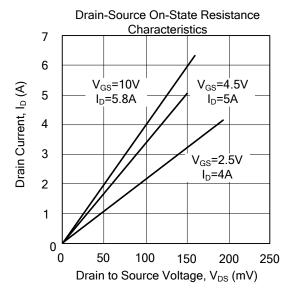
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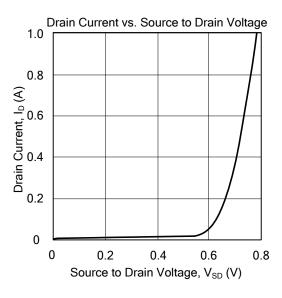
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#### ■ TYPICAL CHARACTERISTICS









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